

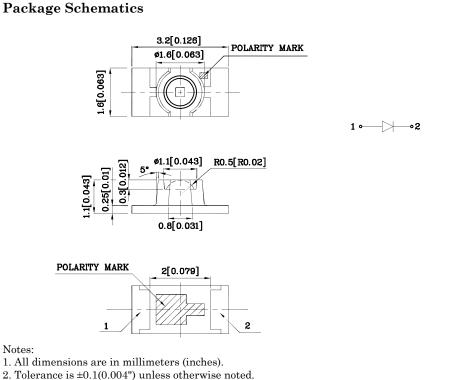
# Part Number: ZVG55W-A2

3.2x1.6mm SMD CHIP LED LAMP

## Features

- $\bullet$  Ideal for indication light on hand held products
- $\bullet$  Long life and robust package
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- $\bullet$  RoHS compliant





3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		VG (AlGaInP)	Unit	
Reverse Voltage	$V_{\mathrm{R}}$	5	V	
Forward Current	$\mathbf{I}_{\mathrm{F}}$	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	150	mA	
Power Dissipation	PD	75	mW	
Operating Temperature	$T_{\rm A}$	$\text{-}40 \sim \text{+}85$	°C	
Storage Temperature	Tstg	$-40 \sim +85$		

Operating Characteristics (T <sub>A</sub> =25°C)		VG (AlGaInP)	Unit
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\rm F}$	2.1	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\rm F}$	2.5	V
Reverse Current (Max.) $(V_R=5V)$	$I_R$	10	uA
Wavelength of Peak Emission CIE127-2007*(Typ.) (I <sub>F</sub> =20mA)	λP	574*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λD	570*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$ riangle \lambda$	20	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	15	$_{\rm pF}$

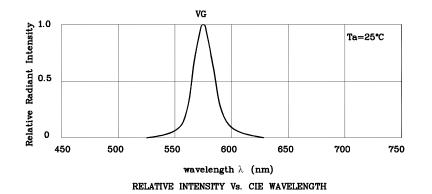
			r	ncd	$\lambda P$	20 1/2
			min.	typ.		
ZVG55W-A2 Green	AlGaInP	Water Clear	55*	98*	574*	70°

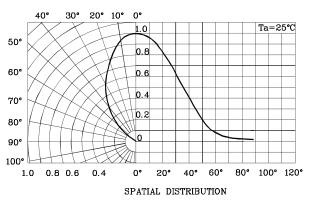
\*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

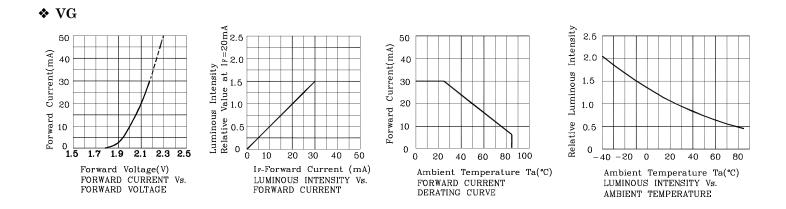
Feb 17,2014

SDSA6231 V3-Z Layout: Maggie L.

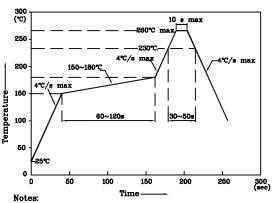








# LED is recommended for reflow soldering and soldering profile is shown below.



Reflow Soldering Profile for SMD Products (Pb-Free Components)

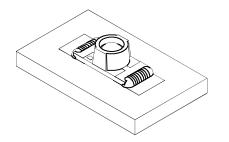
1. Maximum soldering temperature should not exceed 260°C

Recommended reflow temperature: 145°C-260°C
Do not put stress to the epoxy resin during

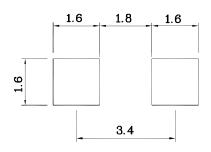
high temperatures conditions



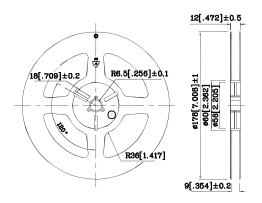
✤ The device has a single mounting surface. The device must be mounted according to the specifications.



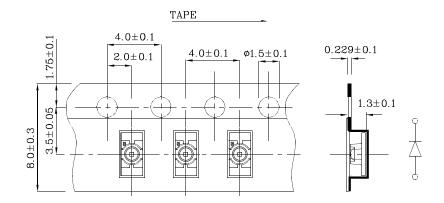
#### Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



## Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

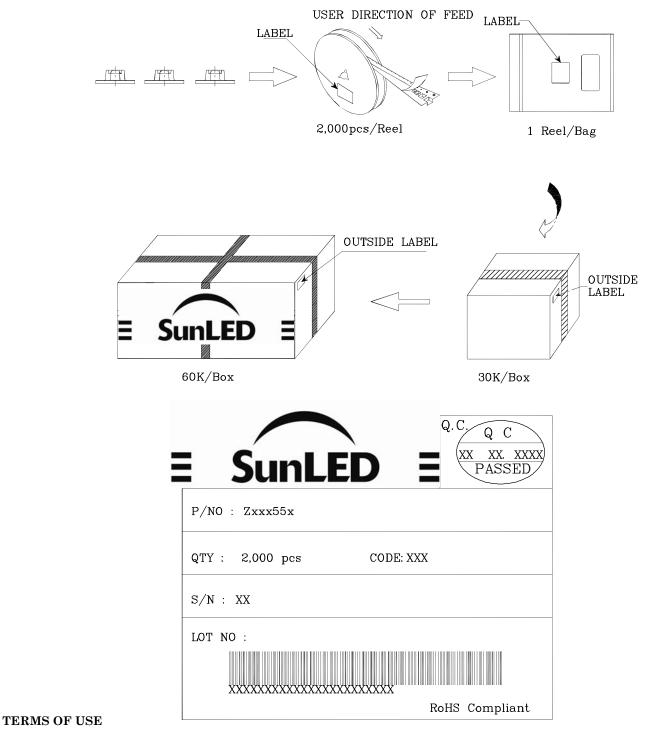
2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V  $\,$ 

Note: Accuracy may depend on the sorting parameters.



#### PACKING & LABEL SPECIFICATIONS



- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet.
- User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
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- 6. Additional technical notes are available at http://www.SunLED.com/TechnicalNotes